







## DISCRIPTION

### **FEATURES**

Molded construction
Heat Resistance Molded Resin
Excellent Mechanical Strength
Excellent Solderability
High Reliability
Low Profile

### **OPTIONS**

Tape & Reel is Standard (Qty: 2000 Pcs)
Bulk Packing Available for smaller quantites
Tolerance: J = 5% and K=10% is Standard,
tighter Tolerance available (MOQ on request)

### **APPLICATIONS**

VCRs DC/DC Converts
Video Cameras CTV, VCR HIC
Communication System
Automotive Systems
LCD/PDP Televisions
Hard Disk Drives
Network Systems
Computer Peripheral Equipment

## PHYSICAL CHARACTERISTICS

 Testing: (Equivalents acceptable) Inductance: HP4285A RDC: QuadTech 1880 mΩ Q: HP4342A SRF: HP4291A

• IDC Max: Determined when superimosed DC current is decreased 10% against it's initial value

Operating Temperature : -25°C ~ +85°C
 Storage Temperature : -40°C ~ +85°C

Solder methods: Wave, Vapor Phase, Infrared
 Resistance to soldering heat: 260°C for 10 seconds
 Solvent resistance: Conforms to MIL-STD-202E

• Marking : Inductance & Tolercane

## **ELECTRICAL SPECIFICATIONS**

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	33	μH	see Site 2
Q factor		Q	30		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	5,6	Ω	max.
Self-Res. Freq.		SRF	17	Mhz	min.
Test-Freq.			2,52	Mhz	
Rated Current		IDC	70	mA	max.
Saturation Current		Isat		mA	typ.

1. This electronic component is meant to be used in general electronic equipment. Before the incorporation SMT WOUND MOLDED of this component into any equipment with higher and more reliable requirements such as aviation, CHIP INDUCTORS aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon -Components must be informed before the stage of design-in. Evaluation checks for safety have to be Part No.: S14002-330 performed on each electronic components used in electrical circuits that require high safety and reliability functions. Customer: DRW: Chang CHKD Young MATL: Chu Chi DATE 09.06.2009 APPD: **FINISH** Vienna Pong Sheet 1 from 2



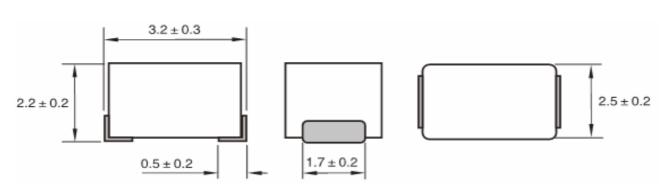






## **TECHNICAL INFORMATIONS**

## Dimensions ( mm )



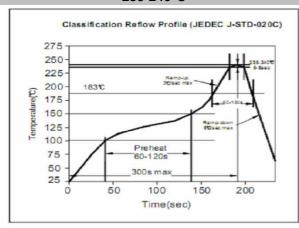
### **Ordering Information**

Serie and Range				
S14002-330				

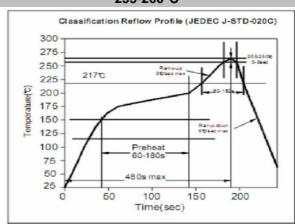
Tolerance	ROHS	Packing	
K	R	TR	

<b>J</b> = 5%	R = ROHS	<b>BU</b> = Bulk Ware
<b>K</b> = 10%	N = non ROHS	TR = Tape Reel
<b>M</b> = 20%		
<b>N</b> = 30%		

# Soldering Profile for Lead Free Soldering 235-240°C



## Soldering Profile for Lead Free Soldering 255-260°C



1. This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon —Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability

functions.

## SMT WOUND MOLDED CHIP INDUCTORS

Part No.: **\$14002-330** 

Customer:

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